

MGV High Current Molded SMT Power Inductors MGV0512 Series

FEATURES AND APPLICATIONS

Laird MGV series high current power inductors improve performance, reliability and power efficiency. A lower profile benefits consumer electronics and telecom design. Products feature extremely low DCR with greater efficiency and enable a large current in a small size. Inductors are of magnetic shielding and molded construction and perform in operating temperatures ranging from -55 C to 125 C including self-heating rise in temperature.

FEATURES

- Magnetic shielded structure
- Low DCR and high efficiency
- Low profile and miniaturization
- High reliability

APPLICATIONS

- DC-DC Converter and Power Suppliers
- LCD TV'S and Gaming Console
- Tablet, Notebooks, Servers and Printers
- Networking and Data storage
- GPS, Set-top-box and Base stations

MGV 0512 / R7

• Smart meters and Medical instruments

PART NUMBER EXPLANATION



	0 7 1 2	+ N /		ТU
Product series code	Product size code	Inductance value code (i.e. 4R7: 4.7	Tolerance % (i.e. M: \pm 20%)	Standard Catalog P.N

Note: Automotive grade parts are also available, a specific P.N will be assigned upon request. Please contact laird local sales for details.

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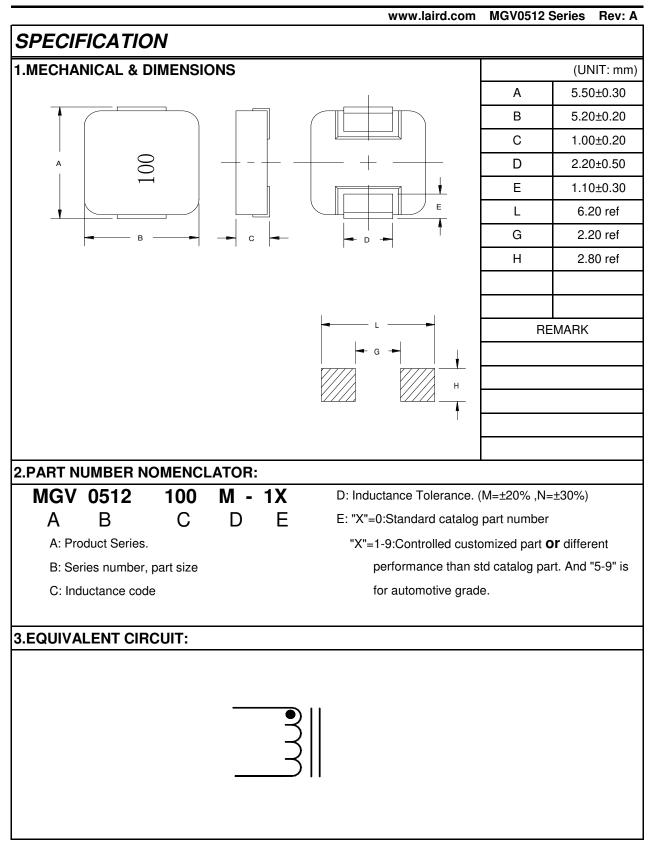
ELECTRICAL SPECIFICATIONS

- Tolerance: M: ±20% or N: ±30%
- Inductance tested at 100KHz, 1.0V
- Heat Rated Current (Irms) is defined based on temperature rise approximate 40°C without core loss (ambient temperature 25±5°C)
- Saturation Current (Isat) is the DC current at which the inductance drops off approximately 30% from its value without current. (ambient temperature 25±5°C)
- Operating temperature range: -40°C~+125°C (including self-heating temperature rise)
- Storage temperature range (packaging conditions): -10°C~+40°C and RH 60%(MAX.)

Note: Heat Rated Current (Irms) is tested on a typical PCB and apply a constant current in still air.

The temperature rise is dependent on the application system condition including PCB PAD pattern, trace width and thickness and adjacent components etc. It's suggested to verify the temperature rise of the component under the real operation application conditions.







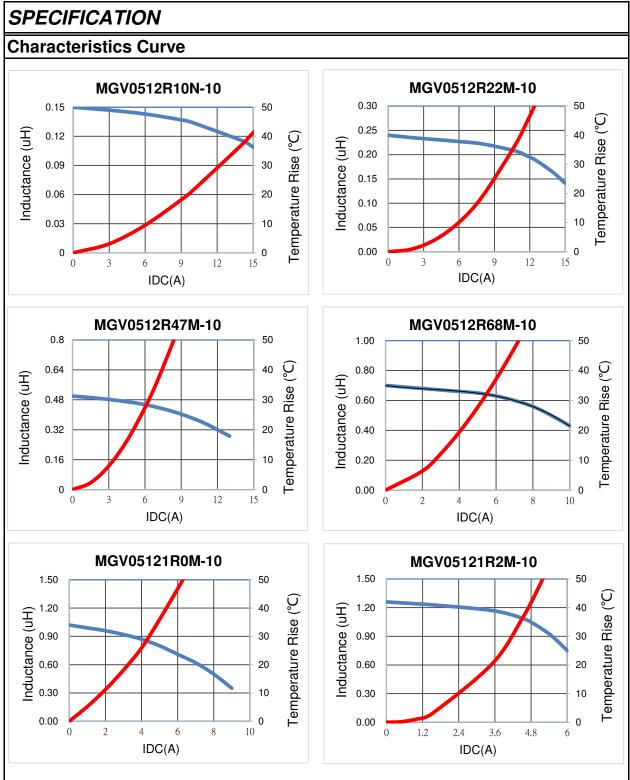
SPECIFICATIOI PART NUMBER	V			www.laird.com	MGV0512 Seri	es Rev: /
PART NUMBER						
	IDUCTANCE (uH)	Irms(A) Typ.	Isat(A) Typ.	DCR(mΩ) Typ	DCR(mΩ) Max	REMARK
MGV0512R10N-10	0.10±30%	14.0	14.5	4.3	5.2	
MGV0512R22N-10	0.22±30%	10.7	14.0	5.5	6.7	
MGV0512R47M-10	0.47±20%	7.0	11.0	13.6	15.8	
MGV0512R68M-10	0.68±20%	6.0	9.0	21.5	24.5	
MGV05121R0M-10	1.00±20%	5.0	6.0	26.0	30.0	
MGV05121R2M-10	1.20±20%	4.5	5.5	33.0	40.0	
MGV05121R5M-10	1.50±20%	4.0	5.0	38.0	44.0	
MGV05122R2M-10	2.20±20%	3.5	4.0	65.0	75.0	
MGV05123R3M-10	3.30±20%	3.0	3.8	75.0	86.0	
MGV05124R7M-10	4.70±20%	2.5	3.2	100.0	115.0	
MGV05126R8M-10	6.80±20%	2.0	3.0	193.0	222.0	
MGV0512100M-10	10.0±20%	1.5	1.8	335.0	385.0	
MGV0512150M-10	15.0±20%	1.3	1.6	410.0	470.0	
ENERAL SPECIFIC	ATION:					
Inductance tested at 2	100KHz, 0.25V					
Heat Rated Current (II	rms) is defined	based on tem	perature rise	approximate 40°	C without core lo	SS
(ambient temperature	e 25±5°C)					
• Saturation Current (Is	at) is the DC cu	rrent at which	the inductan	ce drops off app	roximately 30% fi	om
its value without curr	ent. (ambient t	emperature 2	5±5°C)			
Operating temperatur	re range: -40°C	~+125°C (inclu	ding self-hea	ting temperature	rise)	
Storage temperature						



Laird Performance Materials

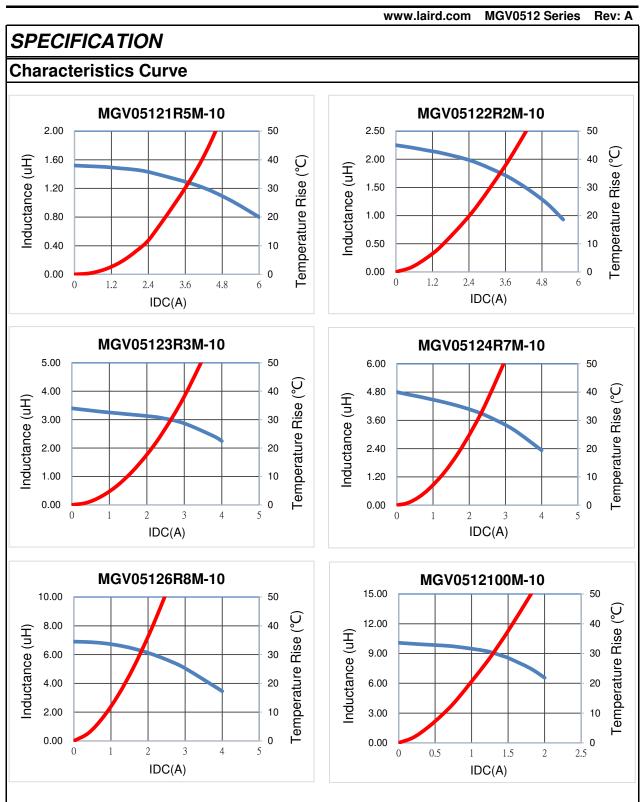
Molded SMT Power Inductors

www.laird.com MGV0512 Series Rev: A





Laird Performance Materials



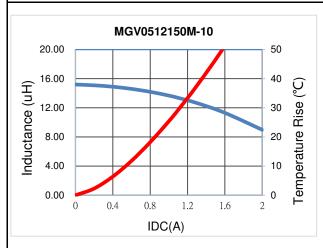


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SPECIFICATION

Characteristics Curve

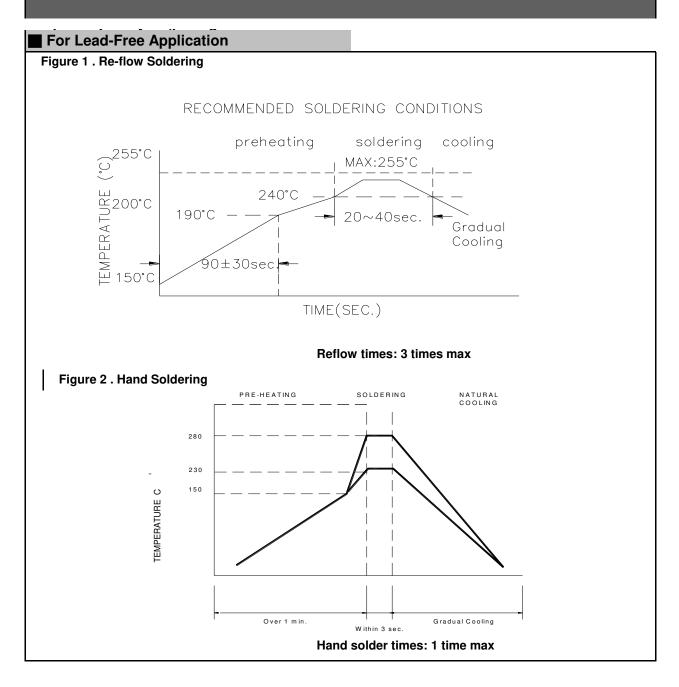




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Recommended Soldering Conditions

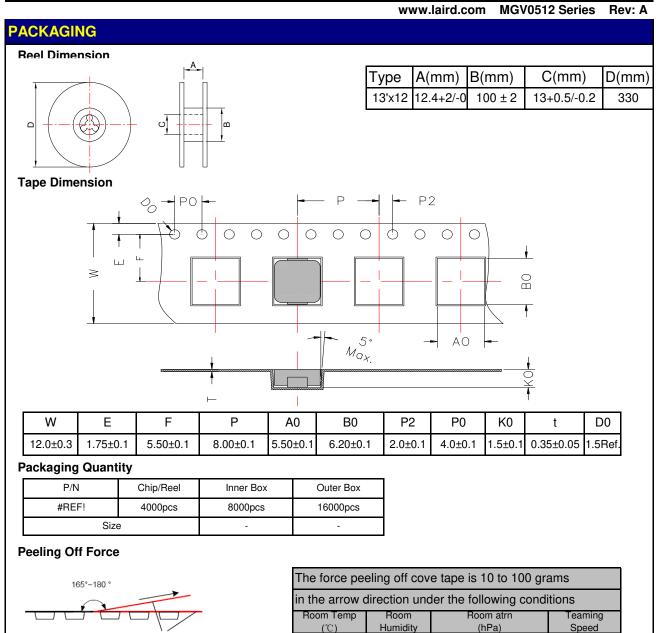




		www.laird.com MGV0512 Series Rev: A					
Reliability and Te	stina Conditions / Pin Tvpe Po	wer Inductors					
SMD series(Consumer)							
Item	Reference	Additional Requirements					
Operating temperature range	-55°C ~ +125°C (Including self-temperature rise)						
Storage temperature and humidity range	-10 $^\circ\!\mathrm{C}$ to +40 $^\circ\!\mathrm{C}$, 60% RH Max						
High Temperature Exposure (Storage)	MIL-STD-202 Method 108	85±2℃, 168+24hours					
Temperature Cycling	JESD22 Method JA-104	-40 °C → +85, transforming interval:20s, 100cycles					
Operational Life	MIL-PRF-2	$85\pm^{\rm C}$, 168+24hours Apply maximum rated voltage and current according part drawing					
External Visual	MIL-STD-883 Method 2009	Inspect device construction, marking and workmanship. Electrical Test not required.					
Physical Dimension	JESD22 Method JB-100	Verify physical dimensions to the applicable device detail specification. Note: User(s) and Suppliers spec. Electrical Test not required					
Vibration	MIL-STD-202 Method 204	10~55Hz,1.5mm, 2 hours in each 3mutually perpendicular directions (total of 6 hours)					
Resistance to Soldering Heat	MIL-STD-202 Method 210	1. Max. 260±5°C,10±1s, 2 times 2.Solder Composition: Sn/3Ag/0.5Cu					
Solderability	J-STD-002	245±5℃, 5±1sec, Solder: Sn/3.0Ag/0.5Cu					
Electrical Characterization	Print Spec	Parametrically test per lot and sample size requirements, summary to show Min, Max, Mean and Standard deviation at room as well as Min and Max Operating temperatures					
Board Flex	AEC-Q200-005	2mm,30±1s					
Terminal Strength(SMD)	AEC-Q200-006	10N, 5S, X,Y direct					



Molded SMT Power Inductors



5~35

45~85

860~1060

300

Top cover tape

Storage Conditions

- 1. Temperature and humidity conditions: -10-+40 $^\circ\!\mathrm{C}$
- and 60% RH.

2. Recommended products should be used within 12 month

from the time of manufacturing.

3. The packaging material should be kept where no chlorine

or sulfur exists in the air.

4. Allowable stacking condition of Packaging box: max height 1.5m or 5 boxes stacking